

MOS FIELD EFFECT TRANSISTORS 2SK2361/2SK2362

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2361/2SK2362 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

• Low On-Resistance

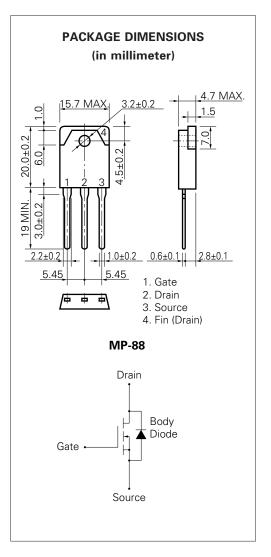
2SK2361: RDS (on) = 0.9 Ω (VGS = 10 V, ID = 5.0 A) 2SK2362: RDS (on) = 1.0 Ω (VGS = 10 V, ID = 5.0 A)

- Low Ciss Ciss = 1050 pF TYP.
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2361/2SK2362)	VDSS	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID (DC)	±10	Α
Drain Current (pulse)*	ID (pulse)	± 40	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	100	W
Total Power Dissipation (T _A = 25 °C)	P_{T2}	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T _{stg} -	55 to +150	°C
Single Avalanche Current**	las	10	Α
Single Avalanche Energy**	Eas	142	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0

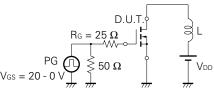


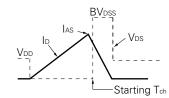


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

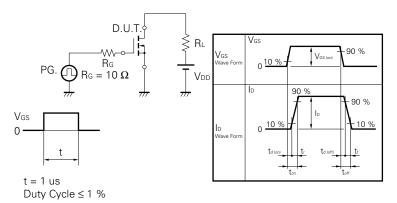
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS (on)		0.7	0.9	Ω	V _{GS} = 10 V	2SK2361
			0.8	1.0	Ω	ID = 5.0 A	2SK2362
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA	
Forward Transfer Admittance	l yfs l	3.0			S	$V_{DS} = 10 \text{ V}, I_{D} = 5.0 \text{ A}$	
Drain Leakage Current	IDSS			100	μΑ	VDS = VDSS, VGS = 0	
Gate to Source Leakage Current	Igss			±100	nA	Vgs = ±30 V, Vps = 0	
Input Capacitance	Ciss		1050		pF	V _{DS} = 10 V	
Output Capacitance	Coss		200		pF	V _G S = 0	
Reverse Transfer Capacitance	Crss		26		pF	f = 1 MHz	
Turn-On Delay Time	td (on)		15		ns	ID = 5.0 A	
Rise Time	tr		24		ns	Vgs = 10 V	
Turn-Off Delay Time	td (off)		50		ns	V _{DD} = 150 V	
Fall Time	tf		14		ns	$R_G = 10 \Omega R$	= 30 Ω
Total Gate Charge	QG		26		nC	ID = 10 A	
Gate to Source Charge	Qgs		6.1		nC	V _{DD} = 400 V	
Gate to Drain Charge	QgD		12		nC	V _G S = 10 V	
Body Diode Forward Voltage	V _F (S-D)		1.0		V	IF = 10 A, VG	s = 0
Reverse Recovery Time	trr		350		ns	IF = 10 A, VG	s = 0
Reverse Recovery Charge	Qrr		2.0		μC	$di/dt = 50 A/\mu s$	

Test Circuit 1 Avalanche Capability

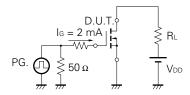




Test Circuit 2 Switching Time

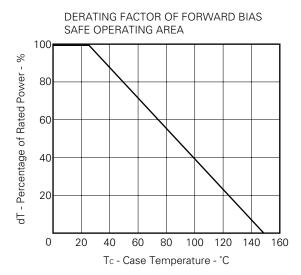


Test Circuit 3 Gate Charge

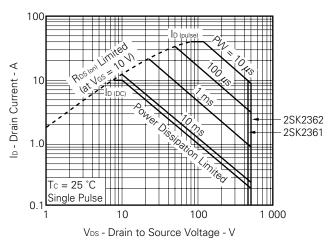


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

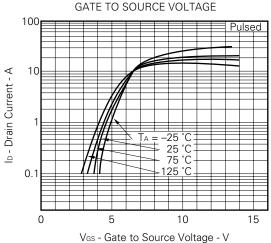
TYPICAL CHARACTERISTICS (TA = 25 °C)







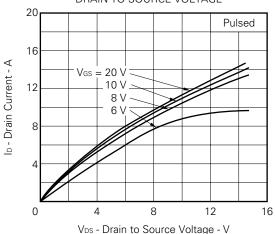
DRAIN CURRENT vs.
GATE TO SOURCE VOLTAGE

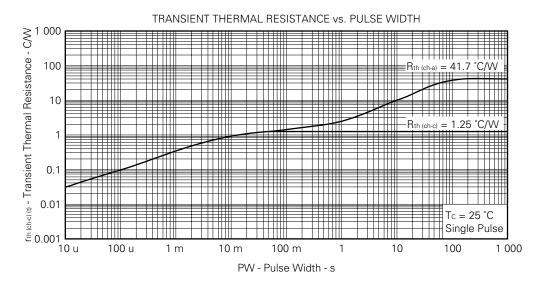


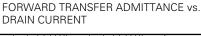
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE 120 P_T - Total Power Dissipation - W 100 80 60 40 20 0 20 40 60 80 100 120 140 160

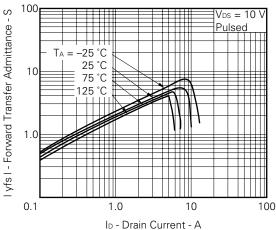
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

Tc - Case Temperature - °C

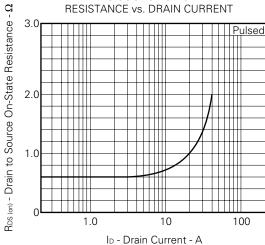




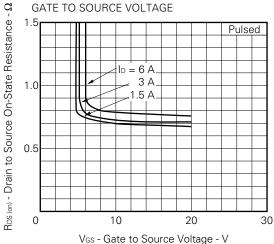




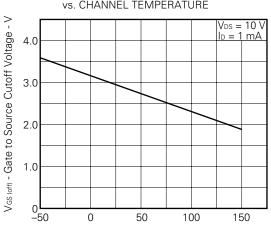
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



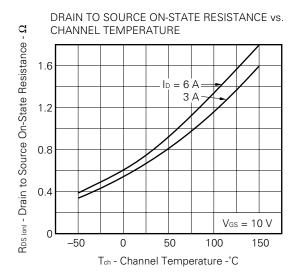
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

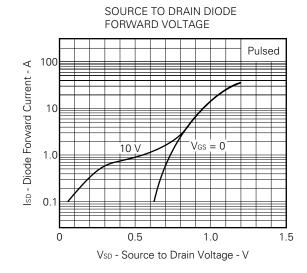


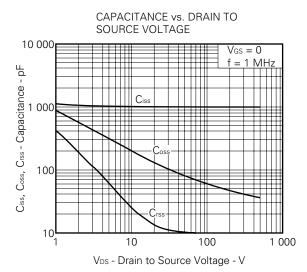
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

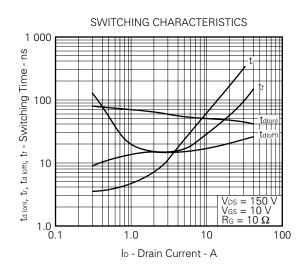


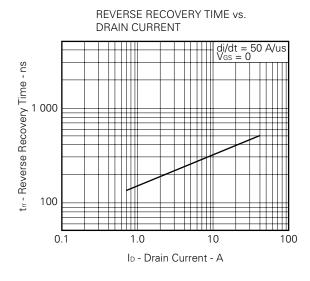
Tch - Channel Temperature - °C

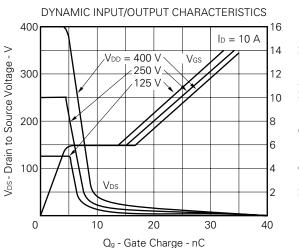






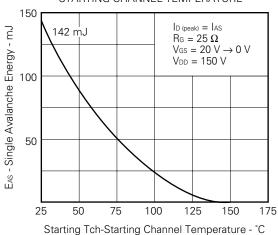




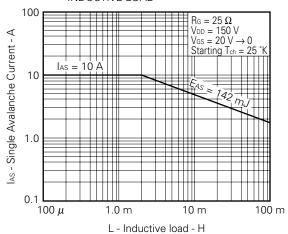




SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

7

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Anti-radioactive design is not implemented in this product.